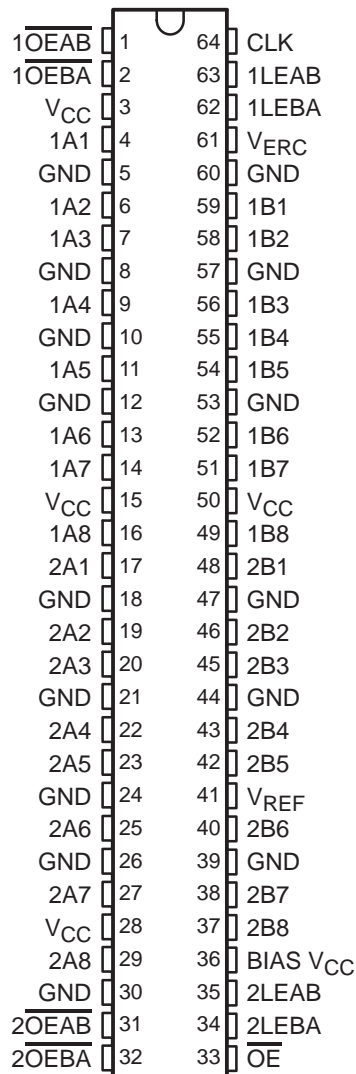


# SN54GTL1655, SN74GTL1655 16-BIT LVTTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS WITH LIVE INSERTION

SCBS696E – JULY 1997 – REVISED NOVEMBER 1999

- **Members of the Texas Instruments Widebus™ Family**
- **UBT™ (Universal Bus Transceiver) Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, or Clocked Mode**
- **Translate Between GTL/GTL+ Signal Level and LVTTTL Logic Levels**
- **High-Drive (100 mA), Low-Output-Impedance (12 Ω) Bus Transceiver (B Port)**
- **Edge-Rate-Control Input Configures the B-Port Output Rise and Fall Times**
- **I<sub>off</sub>, Power-Up 3-State, and BIAS V<sub>CC</sub> Support Live Insertion**
- **Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors on A Port**
- **Distributed V<sub>CC</sub> and GND-Pin Configuration Minimizes High-Speed Switching Noise**
- **Package Options Include Thin Shrink Small-Outline (DGG) and Ceramic Quad Flat (HV) Packages**

**SN74GTL1655 . . . DGG PACKAGE  
(TOP VIEW)**



## description

The 'GTL1655 devices are high-drive (100 mA), low-output-impedance (12 Ω) 16-bit universal bus transceivers (UBT) that provide LVTTTL-to-GTL/GTL+ and GTL/GTL+-to-LVTTTL signal-level translation. They are partitioned as two 8-bit transceivers and combine D-type flip-flops and D-type latches to allow for transparent, latched, and clocked modes of data transfer similar to the '16501 function. These devices provide an interface between cards operating at LVTTTL logic levels and a backplane operating at GTL/GTL+ signal levels. Higher-speed operation is a direct result of the reduced output swing (<1 V), reduced input threshold levels and output edge control (OEC™). The high drive is suitable for driving double-terminated low-impedance backplanes using incident-wave switching.



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# SN54GTL1655, SN74GTL1655 16-BIT LVTTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS WITH LIVE INSERTION

SCBS696E – JULY 1997 – REVISED NOVEMBER 1999

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## description (continued)

The user has the flexibility of using this device at either GTL ( $V_{TT} = 1.2\text{ V}$  and  $V_{REF} = 0.8\text{ V}$ ) or the preferred higher noise margin GTL+ ( $V_{TT} = 1.5\text{ V}$  and  $V_{REF} = 1\text{ V}$ ) signal levels. GTL+ is the Texas Instruments derivative of the Gunning transceiver logic (GTL) JEDEC standard JESD 8-3. The B port normally operates at GTL or GTL+ signal levels, while the A-port and control inputs are compatible with LVTTTL logic levels but are not 5-V tolerant.  $V_{REF}$  is the reference input voltage for the B port.

These devices are uniquely partitioned as two 8-bit transceivers with individual latch timing and output signals, but with a common clock and output enable inputs for both transceiver words.

Data flow for each word is determined by the respective latch enables ( $\overline{xLEAB}$  and  $xLEBA$ ), output enables ( $x\overline{OEAB}$  and  $x\overline{OEBA}$ ), and clock (CLK). The output enables ( $1\overline{OEAB}$ ,  $1\overline{OEBA}$ ,  $2\overline{OEAB}$ , and  $2\overline{OEBA}$ ) control byte 1 and byte 2 data for the A-to-B and B-to-A directions, respectively.

For A-to-B data flow, the devices operate in the transparent mode when LEAB is high. When LEAB transitions low, the A data is latched independent of CLK high or low. If LEAB is low, the A data is registered on the CLK low-to-high transition. When  $\overline{OEAB}$  is low, the outputs are active. With  $\overline{OEAB}$  high, the outputs are in the high-impedance state.

Data flow for the B-to-A direction is identical, but uses  $\overline{OEBA}$ , LEBA, and CLK. Note that CLK is common to both directions and both 8-bit words.  $\overline{OE}$  is also common and is used to disable all I/O ports simultaneously.

The 'GTL1655 is featured with adjustable edge-rate control ( $V_{ERC}$ ). Changing  $V_{ERC}$  input voltage between GND and  $V_{CC}$  adjusts the B-port output rise and fall times. This allows the designer to optimize for various loading conditions.

These devices are fully specified for live-insertion applications using  $I_{off}$ , power-up 3-state, and BIAS  $V_{CC}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict. The BIAS  $V_{CC}$  circuitry precharges and preconditions the B-port input/output connections, preventing disturbance of active data on the backplane during card insertion or removal, and permits true live-insertion capability.

When  $V_{CC}$  is between 0 and 1.5 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry holds unused or undriven LVTTTL inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

The SN54GTL1655 is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN74GTL1655 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

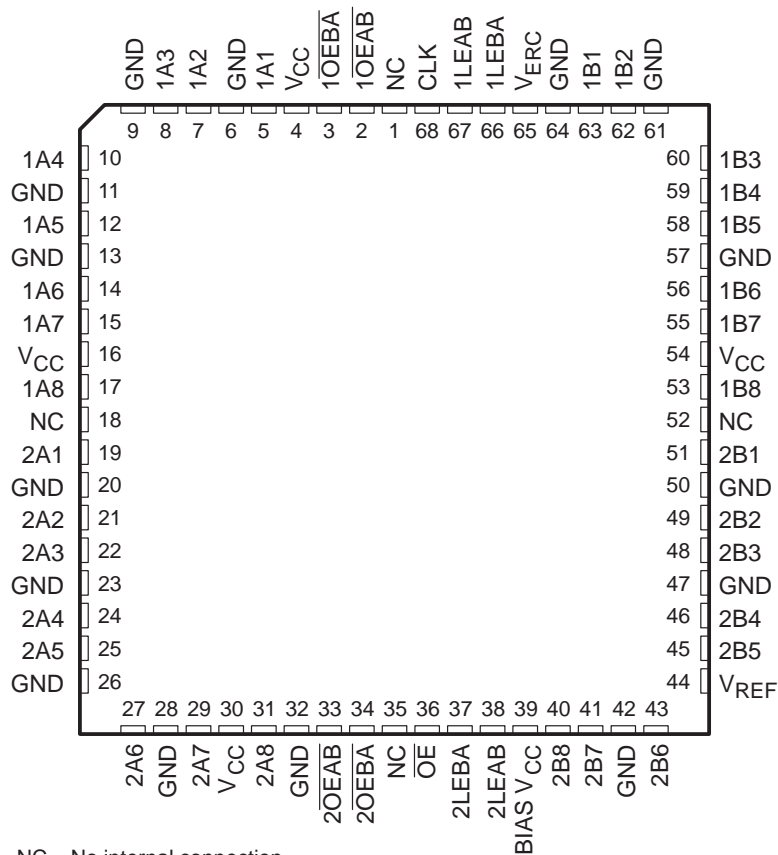


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# SN54GTL1655, SN74GTL1655 16-BIT LVTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS WITH LIVE INSERTION

SCBS696E – JULY 1997 – REVISED NOVEMBER 1999

**SN54GTL1655 . . . HV PACKAGE  
(TOP VIEW)**



**SN54GTL1655, SN74GTL1655**  
**16-BIT LVTTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS**  
**WITH LIVE INSERTION**

SCBS696E – JULY 1997 – REVISED NOVEMBER 1999

**Function Tables**

**FUNCTION†**

INPUTS				OUTPUT B	MODE
$\overline{OEAB}$	LEAB	CLK	A		
H	X	X	X	Z	Isolation
L	H	X	L	L	Transparent
L	H	X	H	H	Transparent
L	L	↑	L	L	Registered
L	L	↑	H	H	Registered
L	L	H	X	$B_0^\ddagger$	Previous State
L	L	L	X	$B_0^\S$	Previous State

† A-to-B data flow is shown. B-to-A flow is similar, but uses  $\overline{OEBA}$ , LEBA, and CLK.

‡ Output level before the indicated steady-state input conditions were established, provided that CLK was high before LEAB went low

§ Output level before the indicated steady-state input conditions were established

**OUTPUT ENABLE**

INPUTS			OUTPUTS	
$\overline{OE}$	$\overline{OEAB}$	$\overline{OEBA}$	A PORT	B PORT
L	L	L	Active	Active
L	L	H	Z	Active
L	H	L	Active	Z
L	H	H	Z	Z
H	X	X	Z	Z

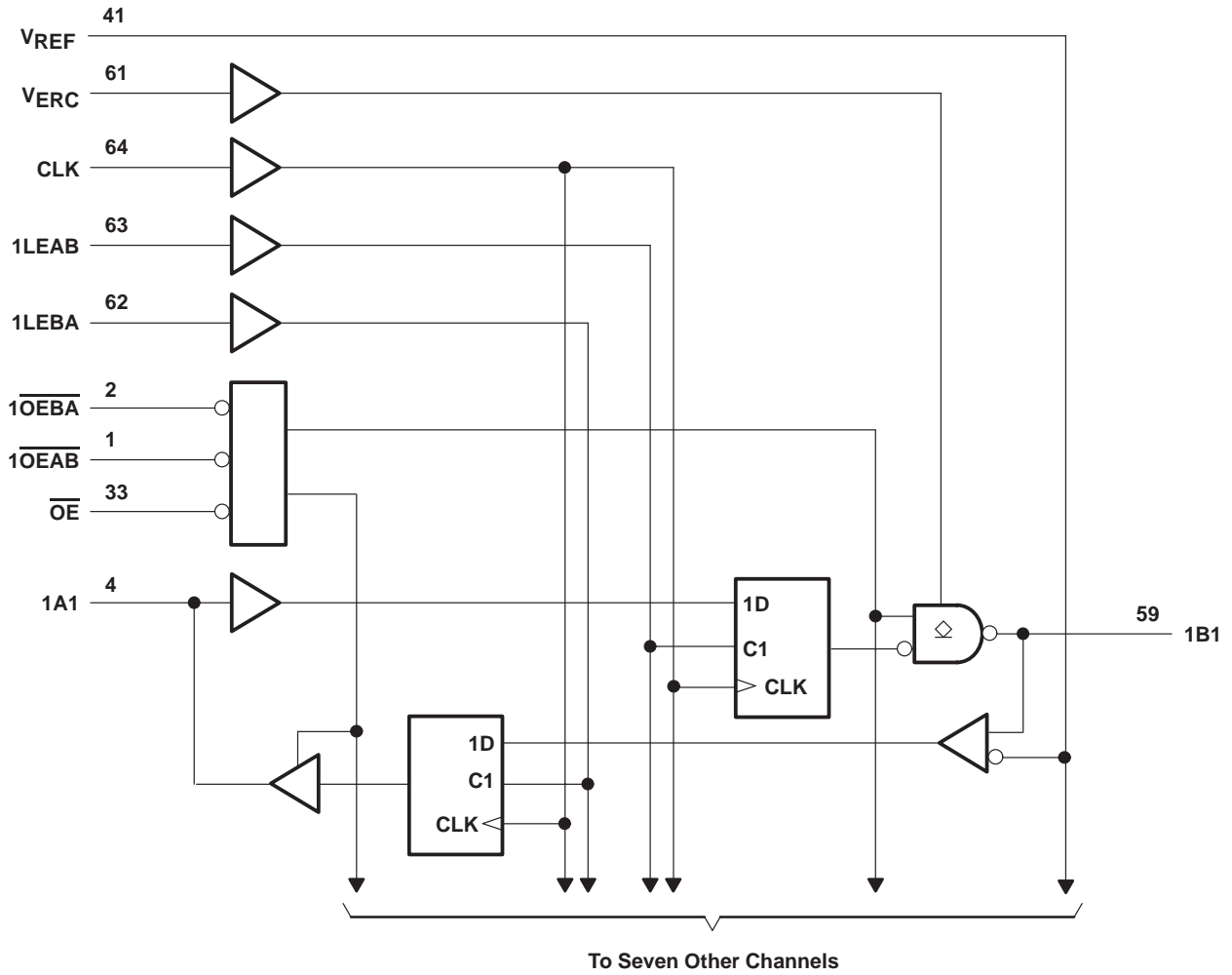
**B-PORT EDGE-RATE CONTROL (V<sub>ERC</sub>)**

INPUT V <sub>ERC</sub>		OUTPUT B PORT EDGE RATE
LOGIC LEVEL	NOMINAL VOLTAGE	
H	V <sub>CC</sub>	Slow
L	GND	Fast

**SN54GTL1655, SN74GTL1655**  
**16-BIT LVTTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS**  
**WITH LIVE INSERTION**

SCBS696E – JULY 1997 – REVISED NOVEMBER 1999

**logic diagram (positive logic)**

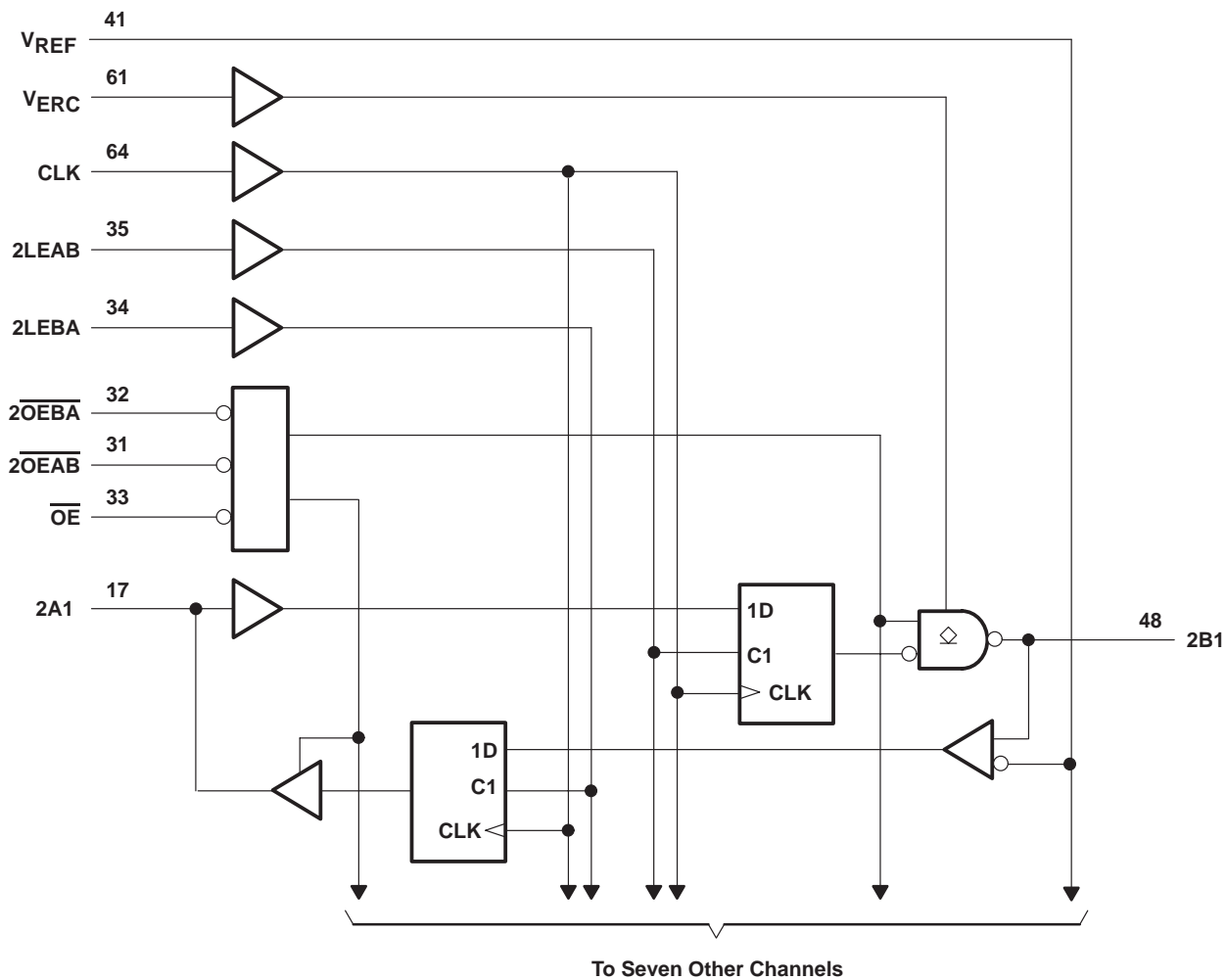


Pin numbers shown are for the DGG package.

# SN54GTL1655, SN74GTL1655 16-BIT LVTTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS WITH LIVE INSERTION

SCBS696E – JULY 1997 – REVISED NOVEMBER 1999

## logic diagram (positive logic) (continued)



Pin numbers shown are for the DGG package.

SN54GTL1655, SN74GTL1655  
**16-BIT LVTTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS**  
**WITH LIVE INSERTION**

SCBS696E – JULY 1997 – REVISED NOVEMBER 1999

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage range, $V_{CC}$ , BIAS $V_{CC}$ .....	-0.5 V to 4.6 V
Input voltage range, $V_I$ (see Note 1): A-port and control pins .....	-0.5 V to 4.6 V
B port, $V_{ERC}$ , and $V_{REF}$ .....	-0.5 V to 4.6 V
Voltage range applied to any output in the high or power-off state, $V_O$ (see Note 1): A port .....	-0.5 V to 4.6 V
B port .....	-0.5 V to 4.6 V
Current into any output in the low state, $I_O$ : A port .....	48 mA
B port .....	200 mA
Current into any A-port output in the high state, $I_O$ (see Note 2) .....	48 mA
Continuous current through each $V_{CC}$ or GND .....	$\pm 100$ mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ ) .....	-50 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ ) .....	-50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3) .....	55°C/W
Storage temperature range, $T_{stg}$ .....	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
 2. This current flows only when the output is in the high state and  $V_O > V_{CC}$ .  
 3. The package thermal impedance is calculated in accordance with JESD 51.



# SN54GTL1655, SN74GTL1655 16-BIT LVTTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS WITH LIVE INSERTION

SCBS696E – JULY 1997 – REVISED NOVEMBER 1999

## recommended operating conditions (see Notes 4 through 6)

		SN54GTL1655			SN74GTL1655			UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX			
BIAS $V_{CC}$	Supply voltage	3	3.3	3.6	3	3.3	3.6	V		
$V_{TT}$	Termination voltage	GTL	1.14	1.2	1.26	1.14	1.2	1.26	V	
		GTL+	1.35	1.5	1.65	1.35	1.5	1.65		
$V_{REF}$	Supply voltage	GTL	0.74	0.8	0.87	0.74	0.8	0.87	V	
		GTL+	0.87	1	1.1	0.87	1	1.1		
$V_I$	Input voltage	B port	0	$V_{TT}$		0	$V_{TT}$		V	
		Except B port	0	$V_{CC}$		0	$V_{CC}$			
$V_{IH}$	High-level input voltage	B port	$V_{REF}+50\text{ mV}$			$V_{REF}+50\text{ mV}$			V	
		$V_{ERC}$	$V_{CC}-0.6$	$V_{CC}$		$V_{CC}-0.6$	$V_{CC}$			
		Except B port and ERC	2			2				
$V_{IL}$	Low-level input voltage	B port	$V_{REF}-50\text{ mV}$			$V_{REF}-50\text{ mV}$			V	
		$V_{ERC}$	GND		0.6	GND		0.6		
		Except B port and ERC	0.8			0.8				
$I_{IK}$	Input clamp current	-18			-18			mA		
$I_{OH}$	High-level output current	A port					-24	mA		
$I_{OL}$	Low-level output current	A port					24	mA		
		B port					100			
$\Delta t/\Delta V_{CC}$	Power-up ramp rate	200			200			$\mu\text{s}/\text{V}$		
$T_A$	Operating free-air temperature	-55			125			-40	85	$^{\circ}\text{C}$

- NOTES: 4. All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.
5. Normal connection sequence is GND first, BIAS  $V_{CC} = 3.3\text{ V}$  second, and  $V_{CC} = 3.3\text{ V}$ , I/O, control inputs,  $V_{TT}$  and  $V_{REF}$  (any order) last. However, if the B-port I/O precharge is not required, the acceptable connection sequence is GND first and  $V_{CC} = 3.3\text{ V}$ , BIAS  $V_{CC} = 3.3\text{ V}$ , I/O, control inputs,  $V_{TT}$  and  $V_{REF}$  (any order) last. When  $V_{CC}$  is connected, the BIAS  $V_{CC}$  circuitry is disabled.
6.  $V_{TT}$  and  $R_{TT}$  can be adjusted to accommodate backplane impedances as long as they do not exceed the DC absolute  $I_{OL}$  ratings. Similarly,  $V_{REF}$  can be adjusted to optimize noise margins, but normally is  $2/3 V_{TT}$ .



# SN54GTL1655, SN74GTL1655 16-BIT LVTTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS WITH LIVE INSERTION

SCBS696E – JULY 1997 – REVISED NOVEMBER 1999

**electrical characteristics over recommended operating free-air temperature range,  $V_{REF} = 1\text{ V}$  and  $V_{TT} = 1.5\text{ V}$  (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	SN54GTL1655			SN74GTL1655			UNIT	
		MIN	TYP†	MAX	MIN	TYP†	MAX		
$V_{IK}$	$V_{CC} = 3\text{ V}$ , $I_I = -18\text{ mA}$	-1.2			-1.2			V	
$V_{OH}$	A port	$V_{CC} = 3\text{ V to } 3.6\text{ V}$ , $I_{OH} = -100\text{ }\mu\text{A}$	$V_{CC} - 0.2$			$V_{CC} - 0.2$			V
		$V_{CC} = 3\text{ V}$	2.4			2.4			
$V_{OL}$	A port	$V_{CC} = 3\text{ V to } 3.6\text{ V}$ , $I_{OL} = 100\text{ }\mu\text{A}$	0.2			0.2			V
		$V_{CC} = 3\text{ V}$	$I_{OL} = 12\text{ mA}$			0.4			
			$I_{OL} = 24\text{ mA}$			0.55			
	B port	$V_{CC} = 3\text{ V}$	$I_{OL} = 40\text{ mA}$			0.2			
			$I_{OL} = 80\text{ mA}$			0.4			
			$I_{OL} = 100\text{ mA}$			0.5			
$I_I$	Control inputs	$V_{CC} = 3.6\text{ V}$	$V_I = V_{CC}\text{ or GND}$			$\pm 10$			$\mu\text{A}$
	B port		$V_I = V_{TT}\text{ or GND}$			$\pm 10$			
$I_{off}$	$V_{CC} = 0$ , $V_I\text{ or }V_O = 0\text{ to }3.6\text{ V}$				$\pm 100$			$\mu\text{A}$	
$I_I(\text{hold})$	A port	$V_{CC} = 3\text{ V}$	$V_I = 0.8\text{ V}$			75			$\mu\text{A}$
			$V_I = 2\text{ V}$			-75			
		$V_{CC} = 3.6\text{ V}^\ddagger$ , $V_I = 0\text{ to }V_{CC}$	$\pm 500$			$\pm 500$			
$I_{OZH}$	B port	$V_{CC} = 3.6\text{ V}$ , $V_O = 1.5\text{ V}$	10			10			$\mu\text{A}$
$I_{OZL}$	B port	$V_{CC} = 3.6\text{ V}$ , $V_O = 0.4\text{ V}$	-10			-10			$\mu\text{A}$
$I_{OZ}^\S$	A port	$V_{CC} = 3.6\text{ V}$ , $V_O = V_{CC}\text{ or GND}$	$\pm 10$			$\pm 10$			$\mu\text{A}$
$I_{OZPU}$	A port	$V_{CC} = 0\text{ to }3.6\text{ V}$ , $V_O = 0.5\text{ V to }3\text{ V}$ , $OE = \text{low}$	$\pm 50^*$			$\pm 50$			$\mu\text{A}$
$I_{OZPD}$	A port	$V_{CC} = 3.6\text{ V to }0$ , $V_O = 0.5\text{ V to }3\text{ V}$ , $OE = \text{low}$	$\pm 50^*$			$\pm 50$			$\mu\text{A}$
$I_{CC}$	A or B port	$V_{CC} = 3.6\text{ V}$ , $I_O = 0$ , $V_I = V_{CC}\text{ or GND}$	Outputs high			80			mA
			Outputs low			80			
			Outputs disabled			80			
$\Delta I_{CC}^\parallel$	Except B port	$V_{CC} = 3.6\text{ V}$ , A-port or control inputs at $V_{CC}\text{ or GND}$ , One input at $V_{CC} - 0.6\text{ V}$	1			1			mA
$C_i$	Control inputs	$V_I = V_{CC}\text{ or }0$	3	5	3	5	$\mu\text{F}$		
$C_{io}$	A port	$V_O = V_{CC}\text{ or }0$	5	6	5	6	$\mu\text{F}$		
	B port		6	8	6	8			

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

† All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

§ For I/O ports, the parameter  $I_{OZ}$  includes the input leakage current.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

# SN54GTL1655, SN74GTL1655 16-BIT LVTTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS WITH LIVE INSERTION

SCBS696E – JULY 1997 – REVISED NOVEMBER 1999

## live-insertion specifications over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS		SN54GTL1655		SN74GTL1655		UNIT
				MIN	MAX	MIN	MAX	
I <sub>CC</sub> (BIAS V <sub>CC</sub> )	V <sub>CC</sub> = 0 to 3 V	V (B port) = 0 to 1.2 V, V <sub>I</sub> (BIAS V <sub>CC</sub> ) = 3 V to 3.6 V		5		5		mA
	V <sub>CC</sub> = 3 V to 3.6 V			10		10		μA
V <sub>O</sub>	B port	V <sub>CC</sub> = 0,	V <sub>I</sub> (BIAS V <sub>CC</sub> ) = 3.3 V	1	1.2	1	1.2	V
I <sub>O</sub>	B port	V <sub>CC</sub> = 0, V (B port) = 0.4 V, V <sub>I</sub> (BIAS V <sub>CC</sub> ) = 3 V to 3.6 V		-1		-1		μA
		V <sub>CC</sub> = 0 to 3.6 V, $\overline{OE}$ = 3.3 V		100		100		
		V <sub>CC</sub> = 0 to 1.5 V, $\overline{OE}$ = 0 to 3.3 V		100		100		

## timing requirements over recommended ranges of supply voltage and operating free-air temperature, V<sub>TT</sub> = 1.2 V, V<sub>REF</sub> = 0.8 V and V<sub>ERC</sub> = V<sub>CC</sub> or GND for GTL (unless otherwise noted)

				SN54GTL1655		SN74GTL1655		UNIT	
				MIN	MAX	MIN	MAX		
f <sub>clock</sub>	Clock frequency			160		160		MHz	
t <sub>w</sub>	Pulse duration		LE high	3		3		ns	
			CLK high or low	3		3			
t <sub>su</sub>	Setup time		Data before CLK↑	2.7		2.7		ns	
			Data before LE↓	CLK high	2.8		2.8		
				CLK low	2.6		2.6		
t <sub>h</sub>	Hold time		Data after CLK↑	0.4		0.4		ns	
			Data after LE↓	CLK high or low	0.9		0.9		

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# SN54GTL1655, SN74GTL1655 16-BIT LVTTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS WITH LIVE INSERTION

SCBS696E – JULY 1997 – REVISED NOVEMBER 1999

**A-to-B switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $V_{TT} = 1.2\text{ V}$ ,  $V_{REF} = 0.8\text{ V}$  and  $V_{ERC} = V_{CC}$  or  $GND$  for GTL (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54GTL1655		SN74GTL1655		UNIT
			MIN	MAX	MIN	MAX	
$f_{max}$			160		160		MHz
$t_{PLH}$	A	B	3.1	5.2	3.1	5.2	ns
$t_{PHL}$	$V_{ERC} = V_{CC}$		2.6	6.2	2.6	6.2	
$t_{PLH}$	CLK	B	3.4	5.5	3.4	5.5	ns
$t_{PHL}$	$V_{ERC} = V_{CC}$		2.4	5.8	2.4	5.8	
$t_{PLH}$	LEAB	B	3.5	5.8	3.5	5.8	ns
$t_{PHL}$	$V_{ERC} = V_{CC}$		2.6	6.4	2.6	6.4	
$t_{en}$	$\overline{OEAB}$ or $\overline{OE}$	B	3.3	5.4	3.3	5.4	ns
$t_{dis}$	$V_{ERC} = V_{CC}$		2.7	5.9	2.7	5.9	
$t_{PLH}$	A	B	2.3	4.3	2.3	4.3	ns
$t_{PHL}$	$V_{ERC} = GND$		1.9	4.3	1.9	4.3	
$t_{PLH}$	CLK	B	2.7	4.8	2.7	4.8	ns
$t_{PHL}$	$V_{ERC} = GND$		1.8	4.3	1.8	4.3	
$t_{PLH}$	LEAB	B	2.8	4.9	2.8	4.9	ns
$t_{PHL}$	$V_{ERC} = GND$		2	4.8	2	4.8	
$t_{en}$	$\overline{OEAB}$ or $\overline{OE}$	B	2.5	4.5	2.5	4.5	ns
$t_{dis}$	$V_{ERC} = GND$		2	4.2	2	4.2	
Slew rate ( $V_{ERC} = V_{CC}$ )	Both transitions, B outputs (0.6 V to 1.3 V)		1		1		ns/V
Slew rate ( $V_{ERC} = GND$ )	Both transitions, B outputs (0.6 V to 1.3 V)		1		1		ns/V
$t_{sk(o)}^{\dagger}$	Skew between drivers in the same package (switching in the same direction)		1		1		ns
$t_{sk(o)}^{\ddagger}$	Skew between drivers switching in any direction in the same package		1		1		ns

$\dagger$  Skew values are applicable for through mode only.

$\ddagger$  Skew values are applicable for CLK mode only, with all outputs switching simultaneously.

**SN54GTL1655, SN74GTL1655**  
**16-BIT LVTTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS**  
**WITH LIVE INSERTION**

SCBS696E – JULY 1997 – REVISED NOVEMBER 1999

**B-to-A switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $V_{TT} = 1.2\text{ V}$  and  $V_{REF} = 0.8\text{ V}$  for GTL (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54GTL1655		SN74GTL1655		UNIT
			MIN	MAX	MIN	MAX	
$f_{max}$			160		160		MHz
$t_{PLH}$	B	A	1.8	4.7	1.8	4.7	ns
$t_{PHL}$			2.3	4.6	2.3	4.6	
$t_{PLH}$	CLK	A	1.6	4	1.6	4	ns
$t_{PHL}$			1.5	3.4	1.5	3.4	
$t_{PLH}$	LEBA	A	1.7	4	1.7	4	ns
$t_{PHL}$			1.4	3.5	1.4	3.5	
$t_{en}$	$\overline{OEBA}$ or $\overline{OE}$	A	1.3	4.2	1.3	4.2	ns
$t_{dis}$			2	6.1	2	6.1	
$t_{sk(o)}^{\dagger}$	Skew between drivers in the same package (switching in the same direction)		1		1		ns
$t_{sk(o)}^{\ddagger}$	Skew between drivers switching in any direction in the same package		1		1		ns

$\dagger$  Skew values are applicable for through mode only.

$\ddagger$  Skew values are applicable for CLK mode only, with all outputs switching simultaneously.

# SN54GTL1655, SN74GTL1655 16-BIT LVTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS WITH LIVE INSERTION

SCBS696E – JULY 1997 – REVISED NOVEMBER 1999

timing requirements over recommended ranges of supply voltage and operating free-air temperature,  $V_{TT} = 1.5\text{ V}$ ,  $V_{REF} = 1\text{ V}$  and  $V_{ERC} = V_{CC}$  or GND for GTL+ (unless otherwise noted)

		SN54GTL1655		SN74GTL1655		UNIT	
		MIN	MAX	MIN	MAX		
$f_{\text{clock}}$	Clock frequency	160		160		MHz	
$t_w$	Pulse duration	LE high		3		ns	
		CLK high or low		3			
$t_{\text{su}}$	Setup time	Data before CLK $\uparrow$		2.7		ns	
		Data before LE $\downarrow$	CLK high		2.8		
			CLK low		2.6		
$t_h$	Hold time	Data after CLK $\uparrow$		0.4		ns	
		Data after LE $\downarrow$	CLK high or low		0.9		

A-to-B switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $V_{TT} = 1.5\text{ V}$ ,  $V_{REF} = 1\text{ V}$  and  $V_{ERC} = V_{CC}$  or GND for GTL+ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54GTL1655		SN74GTL1655		UNIT
			MIN	MAX	MIN	MAX	
$f_{\text{max}}$			160		160		MHz
$t_{\text{PLH}}$	A	B	3	5.1	3	5.1	ns
$t_{\text{PHL}}$	$V_{ERC} = V_{CC}$		2.9	6.5	2.9	6.5	
$t_{\text{PLH}}$	CLK	B	3.4	5.4	3.4	5.4	ns
$t_{\text{PHL}}$	$V_{ERC} = V_{CC}$		2.7	6.2	2.7	6.2	
$t_{\text{PLH}}$	LEAB	B	3.5	5.7	3.5	5.7	ns
$t_{\text{PHL}}$	$V_{ERC} = V_{CC}$		2.8	6.7	2.8	6.7	
$t_{\text{en}}$	$\overline{\text{OEAB}}$	B	3.3	5.4	3.3	5.4	ns
$t_{\text{dis}}$	$V_{ERC} = V_{CC}$		3	6.3	3	6.3	
$t_{\text{en}}$	$\overline{\text{OE}}$	B	3	5.5	3	5.5	ns
$t_{\text{dis}}$	$V_{ERC} = V_{CC}$		3.6	5.8	3.6	5.8	
$t_{\text{PLH}}$	A	B	2.3	4.3	2.3	4.3	ns
$t_{\text{PHL}}$	$V_{ERC} = \text{GND}$		2	4.4	2	4.4	
$t_{\text{PLH}}$	CLK	B	2.7	4.8	2.7	4.8	ns
$t_{\text{PHL}}$	$V_{ERC} = \text{GND}$		1.9	4.5	1.9	4.5	
$t_{\text{PLH}}$	LEAB	B	2.8	4.9	2.8	4.9	ns
$t_{\text{PHL}}$	$V_{ERC} = \text{GND}$		2.1	4.9	2.1	4.9	
$t_{\text{en}}$	$\overline{\text{OEAB}}$	B	2.5	4.5	2.5	4.5	ns
$t_{\text{dis}}$	$V_{ERC} = \text{GND}$		2.1	4.4	2.1	4.4	
$t_{\text{en}}$	$\overline{\text{OE}}$	B	2.5	4.6	2.5	4.6	ns
$t_{\text{dis}}$	$V_{ERC} = \text{GND}$		2.9	4.9	2.9	4.9	
Slew rate ( $V_{ERC} = V_{CC}$ )	Both transitions, B outputs (0.6 V to 1.3 V)		1		1		ns/V
Slew rate ( $V_{ERC} = \text{GND}$ )	Both transitions, B outputs (0.6 V to 1.3 V)		1		1		ns/V
$t_{\text{sk(o)}}^\dagger$	Skew between drivers in the same package (switching in the same direction)		1		1		ns
$t_{\text{sk(o)}}^\ddagger$	Skew between drivers switching in any direction in the same package		1		1		ns

$^\dagger$  Skew values are applicable for through mode only.

$^\ddagger$  Skew values are applicable for CLK mode only, with all outputs switching simultaneously.

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**SN54GTL1655, SN74GTL1655**  
**16-BIT LVTTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS**  
**WITH LIVE INSERTION**

SCBS696E – JULY 1997 – REVISED NOVEMBER 1999

**B-to-A switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $V_{TT} = 1.5\text{ V}$  and  $V_{REF} = 1\text{ V}$  for GTL+ (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54GTL1655		SN74GTL1655		UNIT
			MIN	MAX	MIN	MAX	
$f_{max}$			160		160		MHz
$t_{PLH}$	B	A	2	4.8	2	4.8	ns
$t_{PHL}$			2.4	4.7	2.4	4.7	
$t_{PLH}$	CLK	A	1.6	4.4	1.6	4.4	ns
$t_{PHL}$			1.5	3.4	1.5	3.4	
$t_{PLH}$	LEBA	A	1.7	4	1.7	4	ns
$t_{PHL}$			1.4	3.5	1.4	3.5	
$t_{en}$	$\overline{OEBA}$	A	1.3	4.2	1.3	4.2	ns
$t_{dis}$			2	6.1	2	6.1	
$t_{en}$	$\overline{OE}$	A	2.2	4.7	2.2	4.7	ns
$t_{dis}$			4.1	6.3	4.1	6.3	
$t_{sk(o)}^{\dagger}$	Skew between drivers in the same package (switching in the same direction)			1		1	ns
$t_{sk(o)}^{\ddagger}$	Skew between drivers switching in any direction in the same package			1		1	ns

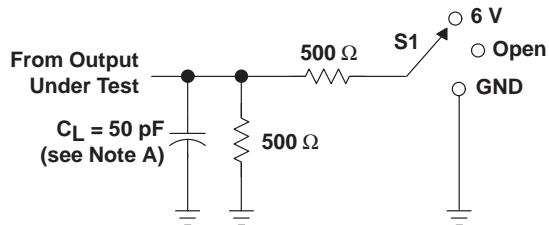
$\dagger$  Skew values are applicable for through mode only.

$\ddagger$  Skew values are applicable for CLK mode only, with all outputs switching simultaneously.

# SN54GTL1655, SN74GTL1655 16-BIT LVTTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVERS WITH LIVE INSERTION

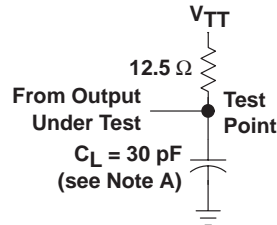
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## PARAMETER MEASUREMENT INFORMATION

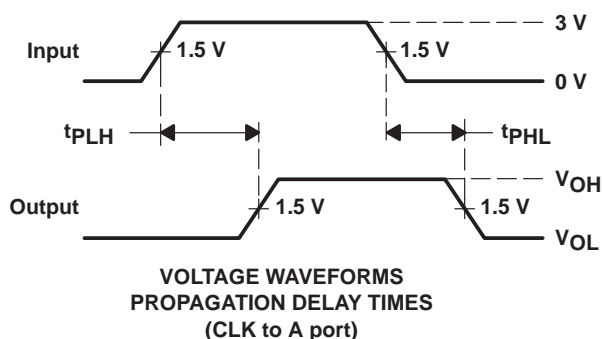
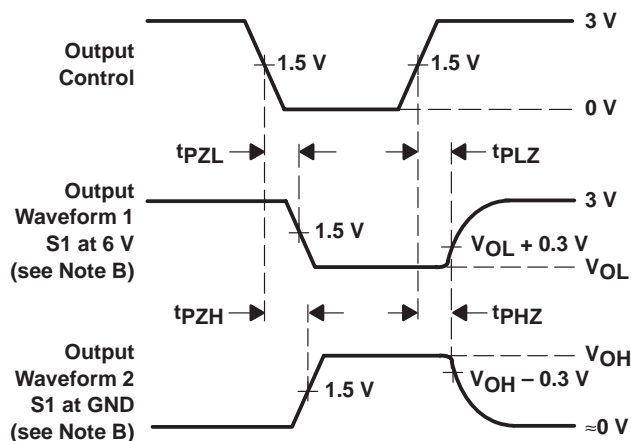
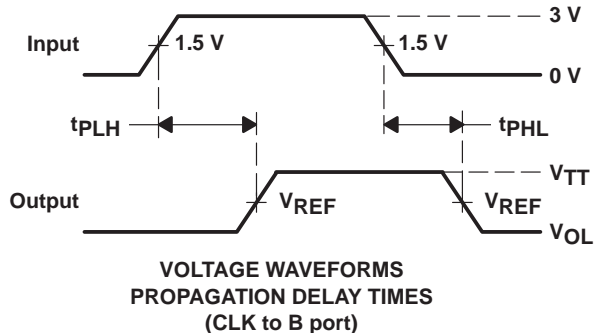
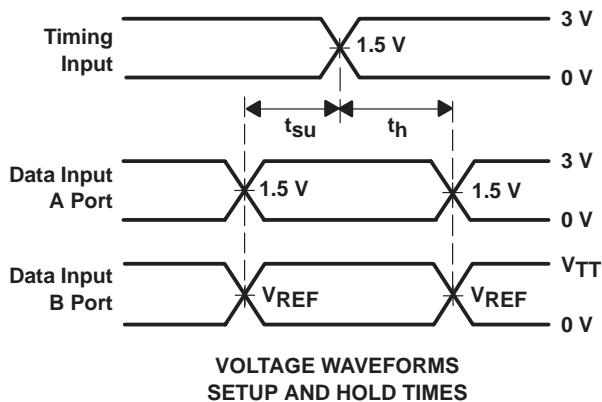
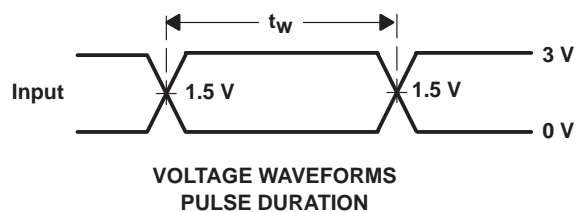


LOAD CIRCUIT FOR A OUTPUTS

TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	6 V
$t_{PHZ}/t_{PZH}$	GND



LOAD CIRCUIT FOR B OUTPUTS



- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10$  MHz,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5$  ns,  $t_f \leq 2.5$  ns.
  - D. The outputs are measured one at a time with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .

Figure 1. Load Circuits and Voltage Waveforms

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